

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Koji ISHIZAKI	05/24/2010
Kouji NOGUCHI	05/26/2010
Takeya TAKEUCHI	05/26/2010
Takayuki NAKANISHI	05/27/2010
Yasuyuki TERANISHI	05/24/2010
RECEIVING PARTY DATA	
Name:	SONY CORPORATION
Street Address:	1-7-1 Konan
Internal Address:	Minato-ku
City:	Tokyo
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12791667
CORRESPONDENCE DATA	
Fax Number:	(312)441-0570
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	312.277.2006
Email:	dayala@rdklaw.com
Correspondent Name:	ROBERT J. DEPKE
Address Line 1:	ROCKEY, DEPKE & LYONS, LLC
Address Line 2:	SUITE 5450 SEARS TOWER
Address Line 4:	CHICAGO, ILLINOIS 60606-6306
ATTORNEY DOCKET NUMBER:	075834.01355
NAME OF SUBMITTER:	Robert J. Depke

CH \$40.00 12791667

Total Attachments: 2
source=Assignment#page1.tif
source=Assignment#page2.tif

Attorney Docket No. 075834.01355
SONY Ref. No.: S10P1028US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in TOUCH DETECTION DEVICE AND DISPLAY DEVICE HAVING TOUCH SENSOR FUNCTION

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: _____, Filing Date: _____.

This assignment executed on the dates indicated below.

KOJI ISHIZAKI
Name of first or sole inventor
AICHI JAPAN
Residence of First or sole inventor
Koji Ishizaki
Signature of first or sole inventor

Execution date of U.S. Patent Application
May 29, 2010
Date of this assignment

KOUJI NOGUCHI
Name of second inventor
KANAGAWA JAPAN
Residence of second inventor
Kouji Noguchi
Signature of second inventor

Execution date of U.S. Patent Application
May 26, 2010
Date of this assignment

TAKEYA TAKEUCHI
Name of third inventor
AICHI JAPAN
Residence of third inventor
Takeya TAKEUCHI
Signature of third inventor

Execution date of U.S. Patent Application
May 26 2010
Date of this assignment

Attorney Docket No. 075834.01355
SONY Ref. No.:S10P1028US00

ADDITIONAL INVENTOR(S)

TAKAYUKI NAKANISHI

Name of fourth inventor

AICHI JAPAN

Residence of fourth inventor

Takayuki Nakanishi
Signature of fourth inventor

Execution date of U.S. Patent Application

May 27, 2010
Date of this assignment

YASUYUKI TERANISHI

Name of fifth inventor

AICHI JAPAN

Residence of fifth inventor

Yasuyuki Teranishi
Signature of fifth inventor

Execution date of U.S. Patent Application

May 24, 2010
Date of this assignment

Name of sixth inventor

Residence of sixth inventor

Signature of sixth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of seventh inventor

Residence of seventh inventor

Signature of seventh inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of eighth inventor

Residence of eighth inventor

Signature of eighth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of ninth inventor

Residence of ninth inventor

Signature of ninth inventor

Execution date of U.S. Patent Application

Date of this assignment